

October 15, 2003

To: Commissioner of Patents and Trademarks
Washington, D.C. 20231

Fr: George O. Saile Reg. No. 19,572
28 Davis Avenue
Poughkeepsie, N.Y. 12603

Subject:

Divisional Patent Application of
Serial No.: 10/054,001 1/19/02

MOU-SHIUNG LIN, JIN-YUAN LEE, CHING-CHENG
HUANG

THIN FILM SEMICONDUCTOR PACKAGE AND
METHOD OF FABRICATION

PRELIMINARY AMENDMENT

Dear Sir:

This is a preliminary amendment for the above referenced Divisional Patent
Application. Please amend the above identified application for patent as follows:

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States
Postal Service as first class mail in an envelope addressed to: Commissioner of Patents
and Trademarks, Washington, D.C. 20231, on October 21, 2003.

Stephen B. Ackerman, Reg. No. 37,761

Signature/Date

